

Specification for Approval

Model Name:

Si	upplier Approv	Customer approval	
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		



Revision Record

REV NO.	REV DATE	CONTENTS	Note
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Table of Contents

List	Description	Page No.
	Cover	1
	Revision Record	2
	Table of Contents	3
1	Scope	4
2	General Information	4
3	External Dimensions	5
4	Interface Description	6
5	Absolute Maximum Ratings	7
6	DC Characteristics	7
7	Timing Characteristics	8
8	Backlight Characteristics	9
9	Optical Characteristics	10
10	Reliability Test Conditions And Methods	12
11	Inspection Standard	13
12	Handling Precautions	17
13	Precaution for Use	18
14	Packing Method	18



1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

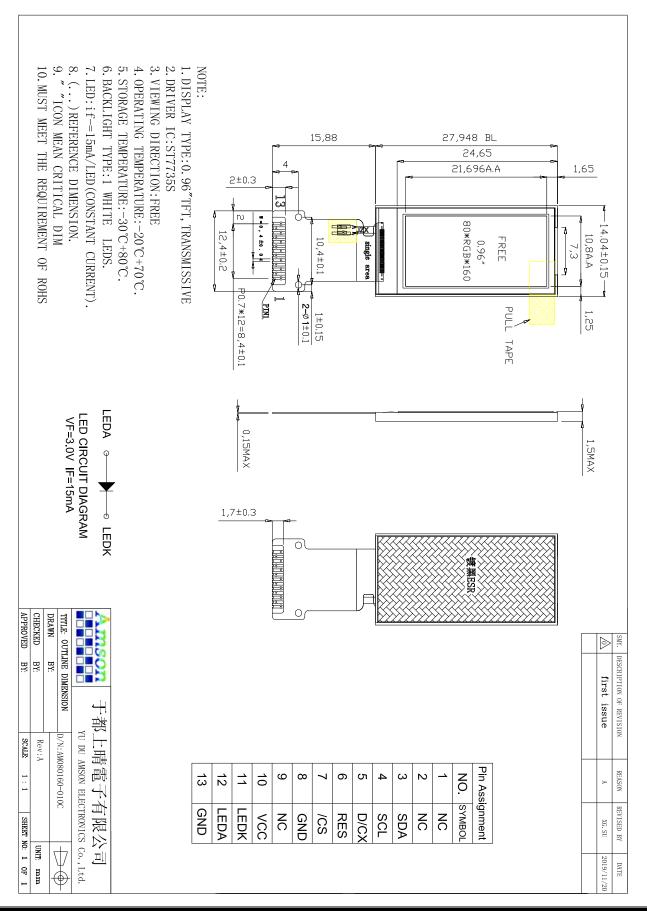
If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	0.96"TFT	
Dot arrangement	80(RGB)×160	dots
Color filter array	RGB vertical stripe	
Display mode	IPS / Transmissive / Normally Black	
Gray scale inversion Direction	80/80/80	
Viewing Direction	ALL	
Driver IC	ST7735S	
Module size	14.040W)×27.948(H)×1.5(T)	mm
Active area	10.800(W)×21.696(H)	mm
Interface	SPI	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	One White LED	



3. External Dimensions





4. Interface Description

PIN.NO	SYMBOL	I/O/P	FUNCTION
1	NC	-	No connect.
2	NC	-	No connect.
3	SDA	I/O	It is used as serial input/output pin in serial interface.
4	SCL	I	The serial clock signal for system
5	D/CX	I	In 4-line SPI, this pin is used as D/CX (data/ command selection); In 3-line SPI, should be fixed at VDDI or DGND.
6	RES	I	-This signal will reset the device and it must be applied to properly initialize the chip. -Signal is active low.
7	/CS	I	Chip Selection PinLow Enable.
8	GND	Р	System Ground
9	NC	-	No connect.
10	VCC	I	Power supply for system.
11	LEDK	I	Ground for backlight.
12	LEDA	I	Power for backlight.
13	GND	Р	System Ground



5. Absolute Maximum Ratings

ltem	Symbol	Min.	Max.	Unit
Analog Supply Voltage	VCC	-0.3	4.6	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Supply Voltage	VCI	2.8		3.3	V	
Input High Voltage	V _{IH}	0.7VCC		VCC	V	Digital input pins
Input Low Voltage	V _{IL}	GND		0.3 VCC	V	Digital input pins
Output High Voltage	V _{OH}	0.8 VCC		VCC	V	Digital output pins
Output Low Voltage	V _{OL}	GND		0.2 VCC	V	Digital output pins
I/O Leak Current	ILI	-0.1		0.1	uA	

Item	Symbol	Min.	Тур.	Max.	Unit	Note
TFT Gate ON Voltage	VGH		(15)		V	*1,*2
TFT Gate OFF Voltage	VGL		(-10)		V	
TFT Common Voltage	Vcom	(-2)		(0)	V	
Data (RGB signal) Voltage	Vsig	(-4.8)		(4.8)	V	

Note:

*1. VGH is TFT Gate operating Voltage.

*2. VGL is TFT Gate operating Voltage.

The storage structure of this model is CST(Storage on Common)

*3. Vcom must be adjusted to optimize display quality _Cross talk, Contrast Ratio and etc.



7. Timing Characteristics

Serial Interface Characteristics

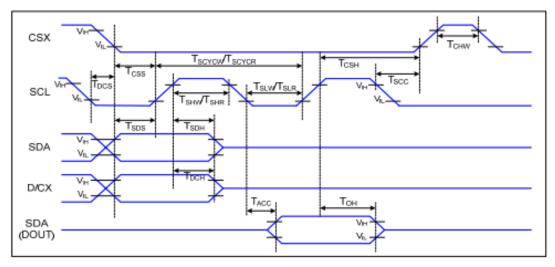


Figure 7 4-line Serial Interface Timing

Ta=25 °C, VDDI=1.65~3.7V, VDD=2.5~4.8V

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	TCSS	Chip Select Setup Time (Write)	45	?	ns	
	TCSH	Chip Select Hold Time (Write)	45		ns	
CSX	TCSS	Chip Select Setup Time (Read)	60		ns	
	TSCC	Chip Select Hold Time (Read)	65		ns	
	TCHW	Chip Select "H" Pulse Width	40		ns	
	TSCYCW	Serial Clock Cycle (Write)	66		ns	-Write Command &
	TSHW	SCL "H" Pulse Width (Write)	15		ns	-write Command & Data Ram
SCL	TSLW	SCL "L" Pulse Width (Write)	15		ns	Data Ram
SUL	TSCYCR	Serial Clock Cycle (Read)	150		ns	-Read Command &
	TSHR	SCL "H" Pulse Width (Read)	60		ns	-Read Command & Data Ram
	TSLR	SCL "L" Pulse Width (Read)	60		ns	
D/CX	TDCS	D/CX Setup Time	10		ns	
DICX	TDCH	D/CX Hold Time	10		ns	
004	TSDS	Data Setup Time	10		ns	
SDA (DIN)	TSDH	Data Hold Time	10		ns	For Maximum CL=30pF
(DIN) (DOUT)	TACC	Access Time	10	50	ns	For Minimum CL=8pF
(5001)	тон	Output Disable Time	15	50	ns	



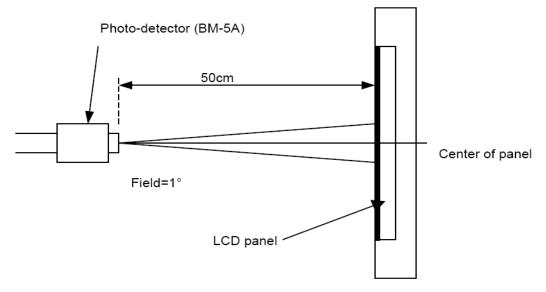
8. Backlight Characteristics

Item	Symbol	MIN	ТҮР	MAX	UNIT	Test Condition
Supply Voltage	Vf	2.8	3.0	3.3	V	lf=15mA
Supply Current	lf		15		mA	
Luminous Intensity for LCM		150	200		Cd/m ²	lf=15mA
Uniformity for LCM		80%			%	lf=15mA
Life Time		20000			Hr	lf=15mA
Backlight Color	White					

9. Optical Characteristics

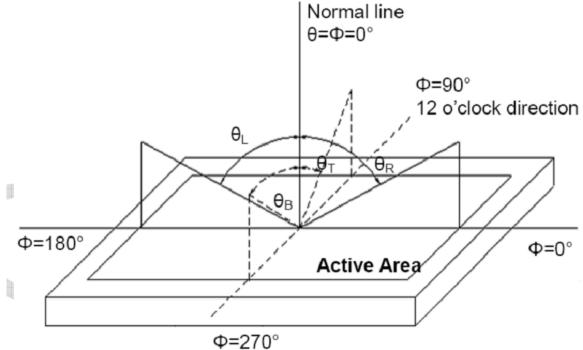
Item	Condition	S	Min.	Тур.	Max.	Unit	Note	
	Llarizantal	θL	-	80	-			
Viewing Angle	Horizontal	θR	-	80	-	dograa	(1) (2) (6)	
(CR>10)	Vertical	θт	-	80	-	degree	(1),(2),(6)	
	vertical	θв	-	80	-			
Contrast Ratio	Center		-	(600)	-	-	(1),(3),(6)	
Response Time	Rising + Fal	ling	-	(30)	(40)	ms	(1),(4),(6)	
	Red x			TBD		-		
	Red y			TBD		-		
	Green x			TBD	Тур.	-		
CF Color	Green y		Тур.	TBD		-	(1) (6)	
Chromaticity (CIE1931)	Blue x		-0.05	TBD	+0.05	-	(1), (6)	
	Blue y			TBD		-		
	White x			TBD		-		
	White y			TBD		-		

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.





Note (2) Definition of Viewing Angle

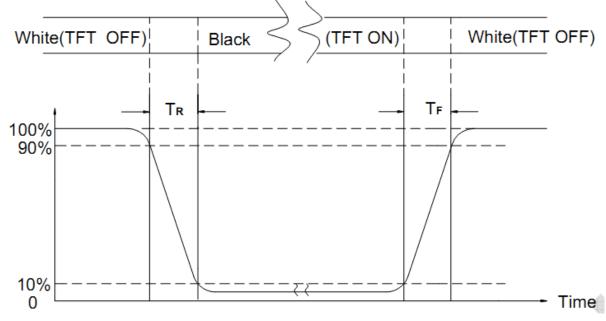


Note (3) Definition Of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input) Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



10. Reliability Test Conditions and Methods

No change on display and in operation under the following test condition. Condition: Unless otherwise specified, tests will be conducted under the following condition.

Temperature: 20±5°CHumidity: 65±5%RHTests will be not conducted under functioning state.

No.	Parameter	Condition	Notes
1	High Temperature Operating	70°C±2°C, 240hrs (Operation state)	
2	Low Temperature Operating	-20°C±2°C, 240hrs (Operation state)	
3	High Temperature Storage	80°C±2°C, 240hrs	
4	Low Temperature Storage	-30°C±2°C, 240hrs	
5	High Temperature and High Humidity Operation Tes t	60°C±2°C, 90%, 240hrs	
6	Vibration Test	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 direction of X, Y, Z each 15 minutes.	
7.	Drop Test	To be measured after dropping from 60cm high on the concrete surface in packing state. F F F G G G G G G G G	

Notes: 1. No dew condensation to be observed.
2. The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.
3. Vibration test will be conducted to the product itself without putting I in a container.



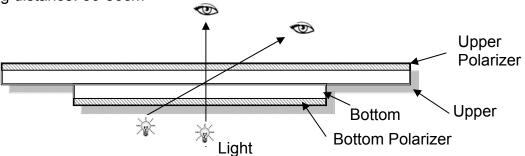
11. Inspection Standard

11.1.1 Inspection conditions

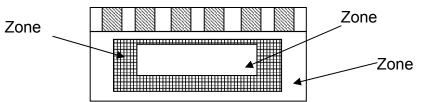
Inspection performed under the following conditions is recommended. Temperature: 25±5°C Humidity: 65%±10%RH Viewing Angle: Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance: 30-50cm



11.1.2 Definition



Zone A: Effective Viewing Area (Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A + Zone B) which cannot be seen after assembly by customer.) Note:

As a general rule, visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer.

11.1.3 Sampling Plan

According to GB/T 2828-2003; normal inspection, Class II AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display, TP: Touch Panel, LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	 No display, Open or miss line Display abnormally, Short Backlight no lighting, abnormal lighting. TP no function 	Major
2	Missing	Missing component	



AM-080160-010C

3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	
5	Soldering appearance	Good soldering, Peeling off is not allowed.	Minor
6	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

11.1.4 Criteria (Visual)

Number	ltems	Criteria(mm)				
	(1) The edge of LCD broken					
		X Y Z				
		≤3.0mm <inner border<br="">line of the seal ≤T</inner>				
1.0 LCD Crack / Broken NOTE: X: Length Y: Width Z: Height L: Length of ITO, T: Height of LCD	(2)LCD corner broken	$\begin{array}{ c c c c c }\hline X & Y & Z \\\hline \leq 3.0 \text{mm} & \leq \text{L} & \leq \text{T} \\\hline \end{array}$				
	(3) LCD crack	Crack Not allowed				

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AM-080160-010C

Version: A

2019-11-20

Number	Items	Criteria (mm)					
		① light dot (LCD/TP/Polarizer black/white spot , light dot, pinhole,					
		dent, stain)					
		Zone	Acceptable Qty		ty		-
		Size (mm)	A	В		С	-
		Ф≤0.10	Ignore				
		0.10<Ф≤0.15	3(distance \geq 10mm)				
		0.15<Φ≤0.2	1	Ignore			
		0.2<Φ	0				
	Spot defect	②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spo					
		Zone	Acceptable Qty				
	Y Y	Size (mm)	А	В		С	
		Φ≤0.1	Igno	re			
	∢ →	0.1<Ф≤0.2	2(distance≧10mm)				
	x Φ=(X+Y)/2	0.2<Ф≤0.3	1		-	Ignore	
2.0		Φ>0.3	0				
		③ Polarizer accidented spot					
		Zone	Acceptable Qty				
		Size (mm)	А	В		С	
		Ф≤0.2	Igno	bre			
		0.2<Φ≤0.5	2(distance	e≧10mm) Ignore		gnore	
		Ф>0.5	0	0			
					•		-
	Line defect (LCD/TP /Polarizer black/white line, scratch, stain)	Midth(mm)	Length(m	Acceptable (Qty	
		Width(mm)	m) `	A	В	С	
		Ф≤0.03	Ignore	Ignore]	
		0.03 <w≤0.05< td=""><td>L≤3.0</td><td>N≤2</td><td></td><td>Ignore</td><td></td></w≤0.05<>	L≤3.0	N≤2		Ignore	
		0.05 <w≤0.08< td=""><td>L≤2.0</td><td>N≤2</td><td></td><td></td><td></td></w≤0.08<>	L≤2.0	N≤2			
		0.08 <w< td=""><td colspan="2">Define as spot defect</td><td>1</td></w<>	Define as spot defect		1		



AM-080160-010C

Version: A

2019-11-20

	Polarizer Bubble	Zone	Acceptable Qty			
		Size (mm)	Α	В	С	
3.0		Ф≤0.2	Ignore			
0.0		0.2<Ф≤0.4	2(distance \geq 10mm)		lanoro	
		0.4<Φ≤0.6	1		Ignore	
		0.6<Ф	0			
4.0	SMT	According to IPC-A-610C class II standard. Function defect and missing part are major defect, the others are minor defect.				



12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to VDD or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.





12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else. [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT , and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD